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(54) Title: METHOD OF MANUFACTURING A REPLICA, AS WELL AS A REPLICA OBTAINED BY CARRYING OUT A
UV LIGHT-INITIATED OR THERMAL CURING TREATMENT OF A REACTIVE MIXTURE

(57) Abstract: The present invention relates to a method of manufacturing a replica, which method comprises the provision of a curable resin composition between a mold and a substrate or a blank, carrying out a UV light-initiated or thermal curing treatment and removing the replica thus manufactured from the mold, which replica comprises the substrate and the reproduction of the mold provided thereon. The invention also relates to a replica obtained by carrying out a UV light-initiated or thermal curing treatment of a reactive compound, especially a replica that has a high transparency for low wavelengths, i.e. 190-400 nm.



WO 2004/054773 A1